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FGAF40N60SMD 600 V, 40 A Field Stop IGBT

Features

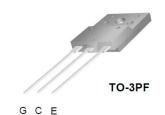
- Maximum Junction Temperature : $T_J = 175^{\circ}C$
- Positive Temperaure Co-efficient for easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: V_{CE(sat)} = 1.9 V(Typ.) @ I_C = 40 A
- High Input Impedance
- Fast Swiching: E_{OFF} = 6.5 uJ/A
- Tightened Parameter Distribution
- RoHS Compliant

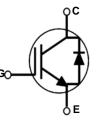
Applications

- Sewing Machine, CNC
- Home Appliances, Motor-Control

General Description

Using novel field stop IGBT technology, ON semiconductor's new series of field stop 2nd generation IGBTs offer the optimum performance for solar inverter, UPS, welder and PFC applications where low conduction and switching losses are essential.





Absolute Maximum Ratings

Symbol	Description		Ratings	Unit	
V _{CES}	Collector to Emitter Voltage		600	V	
V _{GES}	Gate to Emitter Voltage		± 20	V	
I _C	Collector Current	@ T _C = 25 ^o C	80*	A	
	Collector Current	@ T _C = 100°C	40*	A	
I _{CM (1)}	Pulsed Collector Current		120*	А	
I _F	Diode Forward Current	@ T _C = 25 ^o C	40*	A	
	Diode Forward Current	@ T _C = 100°C	20*	A	
I _{FM (1)}	Pulsed Diode Maximum Forward Current		120*	А	
P _D	Maximum Power Dissipation	@ T _C = 25 ^o C	115	W	
· D	Maximum Power Dissipation	@ T _C = 100°C	58	W	
TJ	Operating Junction Temperature		-55 to +175	°C	
T _{stg}	Storage Temperature Range		-55 to +175	°C	
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

Notes:

*Drain current limited by maximum junction temperature

1: Repetitive rating: Pulse width limited by max. junction temperature

Max.

1.3

3.27

Typ.

-

-

Unit

°C/W

°C/W

V

Thermal Resistance, Junction to Ambient 40 °C/W $R_{\theta JA}$ -Package Marking and Ordering Information **Device Marking** Device Package **Reel Size** Tape Width Quantity FGAF40N60SMD FGAF40N60SMD TO-3PF 30 --Electrical Characteristics of the IGBT T_C = 25°C unless otherwise noted Symbol Parameter Test Conditions Min. Тур. Max. Unit **Off Characteristics BV_{CES}** Collector to Emitter Breakdown Voltage $V_{GE} = 0V, I_{C} = 250 \mu A$ 600 -_ Temperature Coefficient of Breakdown ΔBV_{CES} $V_{GE} = 0V, I_{C} = 250 \mu A$ 0.6 V/ºC ΔT_{J} Voltage $V_{CE} = V_{CES}, V_{GE} = 0V$ Collector Cut-Off Current I_{CES} --250 μΑ $V_{GE} = V_{GES}, V_{CE} = 0V$ G-E Leakage Current ±400 I_{GES} -nA **On Characteristics** G-E Threshold Voltage $I_C = 250 \mu A$, $V_{CE} = V_{GE}$ 3.5 4.5 6.0 V $V_{GE(th)}$ $I_{C} = 40A, V_{GE} = 15V$ V -1.9 -V_{CE(sat)} Collector to Emitter Saturation Voltage $I_{C} = 40A, V_{GE} = 15V,$ 2.1 . V $T_{C} = 175^{\circ}C$ **Dynamic Characteristics** Cies Input Capacitance -1880 pF - $V_{CE} = 30V, V_{GE} = 0V,$ Coes **Output Capacitance** -180 pF f = 1MHzC_{res} **Reverse Transfer Capacitance** pF -50 _ **Switching Characteristics** Turn-On Delay Time 12 ns t_{d(on)} 20 **Rise Time** -ns Turn-Off Delay Time 92 ns -t_{d(off)} $V_{CC} = 400V, I_C = 40A,$ $R_G = 6\Omega$, $V_{GE} = 15V$, Inductive Load, $T_C = 25^{\circ}C$ Fall Time -13 17 ns Turn-On Switching Loss 0.87 -Eon mJ 0.26 0.34 Eoff Turn-Off Switching Loss mJ Ets Total Switching Loss 1.13 mJ -Turn-On Delay Time -15 ns t_{d(on)} **Rise Time** 22 ns --

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Turn-Off Delay Time

Turn-On Switching Loss

Turn-Off Switching Loss

Total Switching Loss

Fall Time

Thermal Characteristics

Parameter

Thermal Resistance, Junction to Case

Thermal Resistance, Junction to Case

Symbol

 $R_{\theta JC}$ (IGBT)

R_{0JC}(Diode)

tr

t_f

t,

tf

Eon

Eoff

Ets

t_{d(off)}

ns

ns

mJ

m.J

mJ

116

16

0.97

0.60

1.57

-

-

-

-

-

-

-

-

 $V_{CC} = 400V, I_{C} = 40A,$ $R_G = 6\Omega$, $V_{GE} = 15V$, Inductive Load, $T_C = 175^{\circ}C$

Electrical Characteristics of the IGBT (Continued)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max	Unit
Qg	Total Gate Charge	V _{CE} = 400V, I _C = 40A, V _{GE} = 15V	-	119	-	nC
Q _{ge}	Gate to Emitter Charge		-	13	-	nC
Q _{gc}	Gate to Collector Charge		-	58	-	nC

Electrical Characteristics of the Diode $T_{C} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Unit
V _{FM}	Diode Forward Voltage	I _F = 20A	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	2.3	-	V
			T _C = 175 ^o C	-	1.67	-	
E _{rec}	Reverse Recovery Energy		$T_{\rm C} = 175^{\rm o}{\rm C}$	-	48.9	-	uJ
t _{rr}	Diode Reverse Recovery Time	$I_{\rm E} = 200 \text{d}_{\rm E}/\text{d}_{\rm E} = 2000 \text{d}_{\rm US}$	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	36	-	ns
			T _C = 175 ^o C	-	110	-	
Q _{rr}	Diode Reverse Recovery Charge		$T_{\rm C} = 25^{\rm o}{\rm C}$	-	46.8	-	nC
			$T_{C} = 175^{\circ}C$	-	445	-	

10

15

Typical Performance Characteristics Figure 1. Typical Output Characteristics 120 120 V_{GE}=20V V_{GE}=20V 15V 15V 12V Collector Current, I_c [A] Collector Current, I_c [A] 90 90 10V 1[']2\ 10V 60 60 8V 30 30 $T_C = 25^{\circ}C$ 8V T_C = 175^oC 0 0 2 4 6 8 Collector-Emitter Voltage, V_{CE} [V] 0 10 0 2 4 6 8 Collector-Emitter Voltage, V_{CE} [V] **Figure 3. Typical Saturation Voltage Figure 4. Transfer Characteristics** Characteristics 120 120 Common Emitter V_{CE} = 20V T_C = 25°C Collector Current, I_c [A] Collector Current, Ic [A] 90 90 T_C = 175°C 60 60 Common Emitter 30 30 $V_{GE} = 15V$ $T_{\rm C} = 25^{\rm o} {\rm C}$ — T_C = 175°C 0 └ 0 0 0 5 9 12 1 2 3 4 Collector-Emitter Voltage, V_{CE} [V] 3 6 Gate-Emitter Voltage, VGE [V] Figure 6. Saturation Voltage vs. V_{GE} Figure 5. Saturation Voltage vs. Case **Temperature at Variant Current Level** 20 Common Emitter Common Emitter Collector-Emitter Voltage, V_{CE} [V] Collector-Emitter Voltage, V_{CE} [V] $V_{GE} = 15V$ $T_c = -40^{\circ}C$ 16 80Å 3 12 80Å 40A 8 40A-2 I_C = 20A 4 I_C = 20A 0 ∟ 4 1 ∟ 25 8 12 16 Gate-Emitter Voltage, V_{GE} [V] 50 75 100 125 150 175 Case Temperature, T_C [°C]

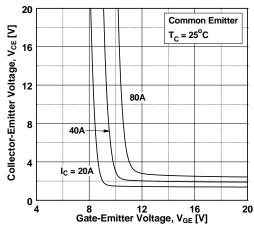
Figure 2. Typical Output Characteristics

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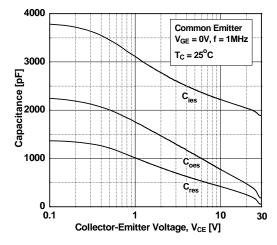
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Typical Performance Characteristics











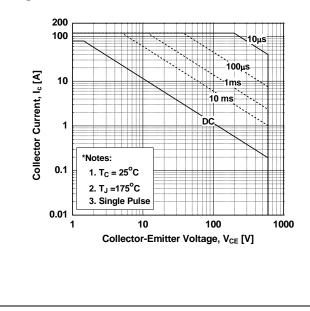


Figure 8. Saturation Voltage vs. V_{GE}

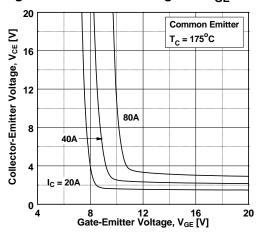


Figure 10. Gate charge Characteristics

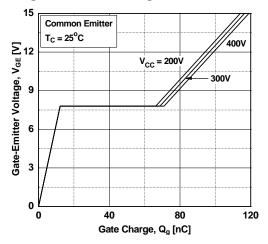
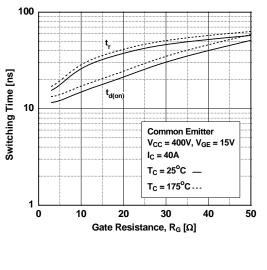
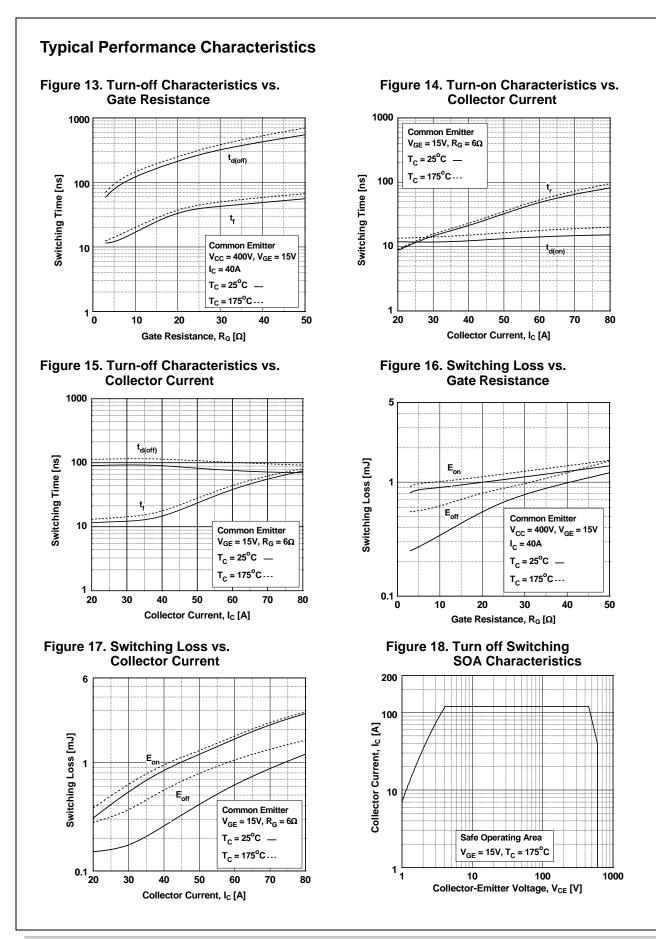
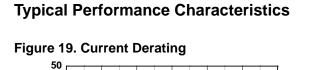


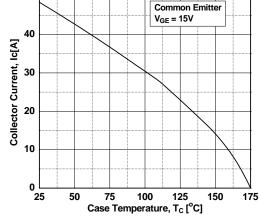
Figure 12. Turn-on Characteristics vs. Gate Resistance



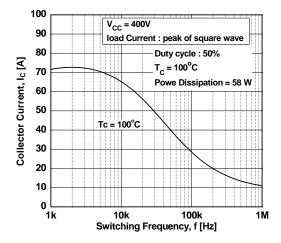


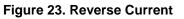
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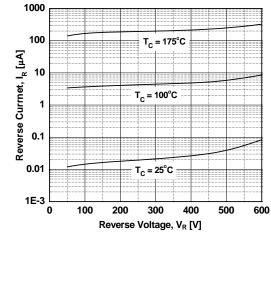


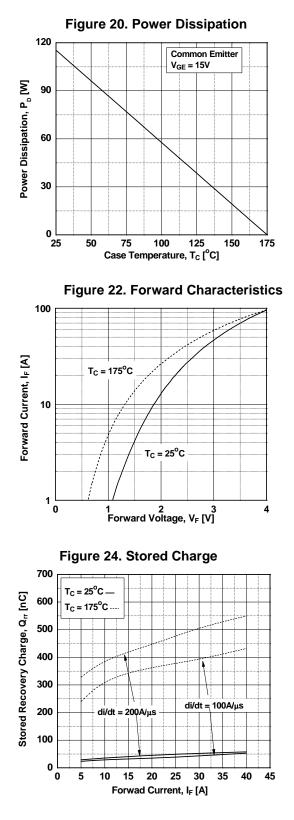


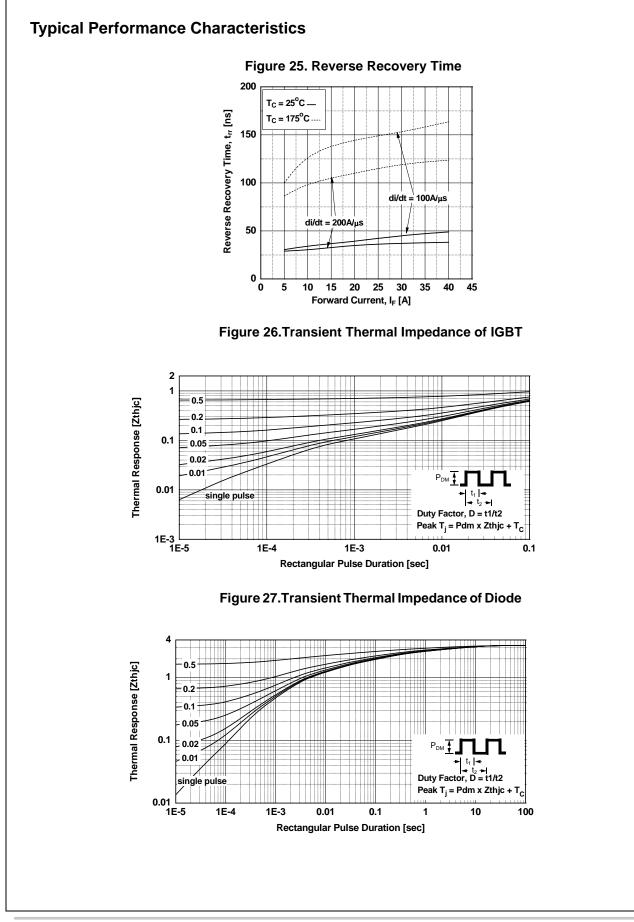


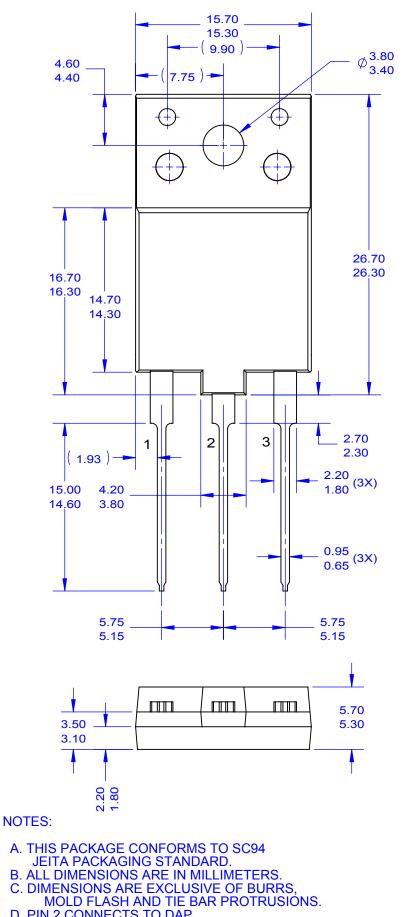




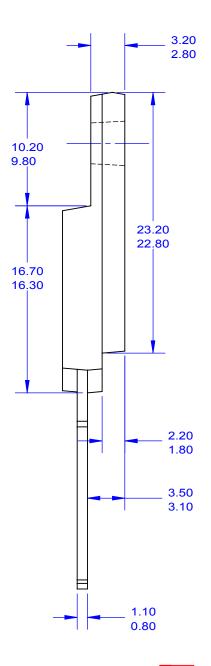














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